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Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| | |
|--------------------------------|---|
| Product Status | Active |
| Number of LABs/CLBs | 1879 |
| Number of Logic Elements/Cells | 24051 |
| Total RAM Bits | 958464 |
| Number of I/O | 226 |
| Number of Gates | - |
| Voltage - Supply | 1.14V ~ 1.26V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 324-LFBGA, CSPBGA |
| Supplier Device Package | 324-CSPBGA (15x15) |
| Purchase URL | https://www.e-xfl.com/product-detail/xilinx/xc6slx25-n3csg324c |

Quiescent Current

Typical values for quiescent supply current are specified at nominal voltage, 25°C junction temperatures (T_j). Quiescent supply current is specified by speed grade for Spartan-6 devices. Xilinx recommends analyzing static power consumption using the XPOWER™ Estimator (XPE) tool (download at <http://www.xilinx.com/power>) for conditions other than those specified in Table 5.

Table 5: Typical Quiescent Supply Current

| Symbol | Description | Device | Speed Grade | | | | Units |
|---------------------|---|--------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| I _{CCINTQ} | Quiescent V _{CCINT} supply current | LX4 | 4.0 | 4.0 | 4.0 | 2.4 | mA |
| | | LX9 | 4.0 | 4.0 | 4.0 | 2.4 | mA |
| | | LX16 | 6.0 | 6.0 | 6.0 | 4.0 | mA |
| | | LX25 | 11.0 | 11.0 | 11.0 | 6.6 | mA |
| | | LX25T | 11.0 | 11.0 | 11.0 | N/A | mA |
| | | LX45 | 15.0 | 15.0 | 15.0 | 9.0 | mA |
| | | LX45T | 15.0 | 15.0 | 15.0 | N/A | mA |
| | | LX75 | 29.0 | 29.0 | 29.0 | 17.4 | mA |
| | | LX75T | 29.0 | 29.0 | 29.0 | N/A | mA |
| | | LX100 | 36.0 | 36.0 | 36.0 | 21.6 | mA |
| | | LX100T | 36.0 | 36.0 | 36.0 | N/A | mA |
| | | LX150 | 51.0 | 51.0 | 51.0 | 31.0 | mA |
| | | LX150T | 51.0 | 51.0 | 51.0 | N/A | mA |
| I _{CCOQ} | Quiescent V _{CCO} supply current | LX4 | 1.0 | 1.0 | 1.0 | 1.0 | mA |
| | | LX9 | 1.0 | 1.0 | 1.0 | 1.0 | mA |
| | | LX16 | 2.0 | 2.0 | 2.0 | 2.0 | mA |
| | | LX25 | 2.0 | 2.0 | 2.0 | 2.0 | mA |
| | | LX25T | 2.0 | 2.0 | 2.0 | N/A | mA |
| | | LX45 | 3.0 | 3.0 | 3.0 | 3.0 | mA |
| | | LX45T | 3.0 | 3.0 | 3.0 | N/A | mA |
| | | LX75 | 4.0 | 4.0 | 4.0 | 4.0 | mA |
| | | LX75T | 4.0 | 4.0 | 4.0 | N/A | mA |
| | | LX100 | 5.0 | 5.0 | 5.0 | 5.0 | mA |
| | | LX100T | 5.0 | 5.0 | 5.0 | N/A | mA |
| | | LX150 | 7.0 | 7.0 | 7.0 | 7.0 | mA |
| | | LX150T | 7.0 | 7.0 | 7.0 | N/A | mA |

SelectIO™ Interface DC Input and Output Levels

Table 7: Recommended Operating Conditions for User I/Os Using Single-Ended Standards

| I/O Standard | V _{CCO} for Drivers ⁽¹⁾ | | | V _{REF} for Inputs | | |
|------------------------|---|--------|--------|--|--------|--------|
| | V, Min | V, Nom | V, Max | V, Min | V, Nom | V, Max |
| LVTTTL | 3.0 | 3.3 | 3.45 | V _{REF} is not used for these I/O standards | | |
| LVC MOS33 | 3.0 | 3.3 | 3.45 | | | |
| LVC MOS25 | 2.3 | 2.5 | 2.7 | | | |
| LVC MOS18 | 1.65 | 1.8 | 1.95 | | | |
| LVC MOS18_JEDEC | 1.65 | 1.8 | 1.95 | | | |
| LVC MOS15 | 1.4 | 1.5 | 1.6 | | | |
| LVC MOS15_JEDEC | 1.4 | 1.5 | 1.6 | | | |
| LVC MOS12 | 1.1 | 1.2 | 1.3 | | | |
| LVC MOS12_JEDEC | 1.1 | 1.2 | 1.3 | | | |
| PCI33_3 ⁽²⁾ | 3.0 | 3.3 | 3.45 | | | |
| PCI66_3 ⁽²⁾ | 3.0 | 3.3 | 3.45 | | | |
| I2C | 2.7 | 3.0 | 3.45 | | | |
| SMBUS | 2.7 | 3.0 | 3.45 | | | |
| SDIO | 3.0 | 3.3 | 3.45 | | | |
| MOBILE_DDR | 1.7 | 1.8 | 1.9 | | | |
| HSTL_I | 1.4 | 1.5 | 1.6 | 0.68 | 0.75 | 0.9 |
| HSTL_II | 1.4 | 1.5 | 1.6 | 0.68 | 0.75 | 0.9 |
| HSTL_III | 1.4 | 1.5 | 1.6 | – | 0.9 | – |
| HSTL_I_18 | 1.7 | 1.8 | 1.9 | 0.8 | 0.9 | 1.1 |
| HSTL_II_18 | 1.7 | 1.8 | 1.9 | – | 0.9 | – |
| HSTL_III_18 | 1.7 | 1.8 | 1.9 | – | 1.1 | – |
| SSTL3_I | 3.0 | 3.3 | 3.45 | 1.3 | 1.5 | 1.7 |
| SSTL3_II | 3.0 | 3.3 | 3.45 | 1.3 | 1.5 | 1.7 |
| SSTL2_I | 2.3 | 2.5 | 2.7 | 1.13 | 1.25 | 1.38 |
| SSTL2_II | 2.3 | 2.5 | 2.7 | 1.13 | 1.25 | 1.38 |
| SSTL18_I | 1.7 | 1.8 | 1.9 | 0.833 | 0.9 | 0.969 |
| SSTL18_II | 1.7 | 1.8 | 1.9 | 0.833 | 0.9 | 0.969 |
| SSTL15_II | 1.425 | 1.5 | 1.575 | 0.69 | 0.75 | 0.81 |

Notes:

- V_{CCO} range required when using I/O standard for an output. Also required for MOBILE_DDR, PCI33_3, LVC MOS18_JEDEC, LVC MOS15_JEDEC, and LVC MOS12_JEDEC inputs, and for LVC MOS25 inputs when V_{CCAUX} = 3.3V.
- For PCI systems, the transmitter and receiver should have common supplies for V_{CCO}.

Table 8: Recommended Operating Conditions for User I/Os Using Differential Signal Standards

| I/O Standard | V _{CCO} for Drivers | | |
|--------------------------|------------------------------|--------|--------|
| | V, Min | V, Nom | V, Max |
| LVDS_33 | 3.0 | 3.3 | 3.45 |
| LVDS_25 | 2.25 | 2.5 | 2.75 |
| BLVDS_25 | 2.25 | 2.5 | 2.75 |
| MINI_LVDS_33 | 3.0 | 3.3 | 3.45 |
| MINI_LVDS_25 | 2.25 | 2.5 | 2.75 |
| LVPECL_33 ⁽¹⁾ | N/A—Inputs Only | | |
| LVPECL_25 | N/A—Inputs Only | | |
| RSDS_33 | 3.0 | 3.3 | 3.45 |
| RSDS_25 | 2.25 | 2.5 | 2.75 |
| TMDS_33 ⁽¹⁾ | 3.14 | 3.3 | 3.45 |
| PPDS_33 | 3.0 | 3.3 | 3.45 |
| PPDS_25 | 2.25 | 2.5 | 2.75 |
| DISPLAY_PORT | 2.3 | 2.5 | 2.7 |
| DIFF_MOBILE_DDR | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_I | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_II | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_III | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_I_18 | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_II_18 | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_III_18 | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL3_I | 3.0 | 3.3 | 3.45 |
| DIFF_SSTL3_II | 3.0 | 3.3 | 3.45 |
| DIFF_SSTL2_I | 2.3 | 2.5 | 2.7 |
| DIFF_SSTL2_II | 2.3 | 2.5 | 2.7 |
| DIFF_SSTL18_I | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL18_II | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL15_II | 1.425 | 1.5 | 1.575 |

Notes:

1. LVPECL_33 and TMDS_33 inputs require V_{CCAUX} = 3.3V nominal.

Table 14: GTP Transceiver Current Supply (per Lane)

| Symbol | Description | Typ ⁽¹⁾ | Max | Units |
|-------------------------|---|---------------------|--------|-------|
| I _{MGTAVCC} | GTP transceiver internal analog supply current | 40.4 | Note 2 | mA |
| I _{MGTAVTTTX} | GTP transmitter termination supply current | 27.4 | | mA |
| I _{MGTAVTTRX} | GTP receiver termination supply current | 13.6 | | mA |
| I _{MGTAVCCPLL} | GTP transmitter and receiver PLL supply current | 28.7 | | mA |
| R _{MGTRREF} | Precision reference resistor for internal calibration termination | 50.0 ± 1% tolerance | | Ω |

Notes:

1. Typical values are specified at nominal voltage, 25°C, with a 2.5 Gb/s line rate, with a shared PLL use mode.
2. Values for currents of other transceiver configurations and conditions can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.

 Table 15: GTP Transceiver Quiescent Supply Current (per Lane)⁽¹⁾⁽²⁾⁽³⁾⁽⁴⁾

| Symbol | Description | Typ ⁽⁵⁾ | Max | Units |
|--------------------------|-------------------------------------|--------------------|--------|-------|
| I _{MGTAVCCQ} | Quiescent MGTAVCC supply current | 1.7 | Note 2 | mA |
| I _{MGTAVTTTXQ} | Quiescent MGTAVTTTX supply current | 0.1 | | mA |
| I _{MGTAVTTRXQ} | Quiescent MGTAVTTRX supply current | 1.2 | | mA |
| I _{MGTAVCCPLLQ} | Quiescent MGTAVCCPLL supply current | 1.0 | | mA |

Notes:

1. Device powered and unconfigured.
2. Currents for conditions other than values specified in this table can be obtained by using the XPOWER Estimator (XPE) or XPOWER Analyzer (XPA) tools.
3. GTP transceiver quiescent supply current for an entire device can be calculated by multiplying the values in this table by the number of available GTP transceivers.
4. Does not include power-up MGTAVTTRCAL supply current during device configuration.
5. Typical values are specified at nominal voltage, 25°C.

Table 17: GTP Transceiver Clock DC Input Level Specification

| Symbol | DC Parameter | Min | Typ | Max | Units |
|-------------|---|-----|-----|------|----------|
| V_{IDIFF} | Differential peak-to-peak input voltage | 200 | 800 | 2000 | mV |
| R_{IN} | Differential input resistance | 80 | 100 | 120 | Ω |
| C_{EXT} | Required external AC coupling capacitor | – | 100 | – | nF |

GTP Transceiver Switching Characteristics

Consult [UG386](#): *Spartan-6 FPGA GTP Transceivers User Guide* for further information.

Table 18: GTP Transceiver Performance

| Symbol | Description | Speed Grade | | | | Units |
|-----------------|---|--------------|--------------|--------------|-----|-------|
| | | -3 | -3N | -2 | -1L | |
| F_{GTPMAX} | Maximum GTP transceiver data rate | 3.2 | 3.2 | 2.7 | N/A | Gb/s |
| $F_{GTPRANGE1}$ | GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 1 | 1.88 to 3.2 | 1.88 to 3.2 | 1.88 to 2.7 | N/A | Gb/s |
| $F_{GTPRANGE2}$ | GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 2 | 0.94 to 1.62 | 0.94 to 1.62 | 0.94 to 1.62 | N/A | Gb/s |
| $F_{GTPRANGE3}$ | GTP transceiver data rate range when PLL_TXDIVSEL_OUT = 4 | 0.6 to 0.81 | 0.6 to 0.81 | 0.6 to 0.81 | N/A | Gb/s |
| $F_{GPLLMAX}$ | Maximum PLL frequency | 1.62 | 1.62 | 1.62 | N/A | GHz |
| $F_{GPLLMIN}$ | Minimum PLL frequency | 0.94 | 0.94 | 0.94 | N/A | GHz |

Table 19: GTP Transceiver Dynamic Reconfiguration Port (DRP) Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|-----------------|--|-------------|-----|-----|-----|-------|
| | | -3 | -3N | -2 | -1L | |
| $F_{GTPDRPCLK}$ | GTP transceiver DCLK (DRP clock) maximum frequency | 125 | 125 | 100 | N/A | MHz |

Table 20: GTP Transceiver Reference Clock Switching Characteristics

| Symbol | Description | Conditions | All LXT Speed Grades | | | Units |
|-------------|---|--|----------------------|-----|-----|---------|
| | | | Min | Typ | Max | |
| F_{GCLK} | Reference clock frequency range | | 60 | – | 160 | MHz |
| T_{RCLK} | Reference clock rise time | 20% – 80% | – | 200 | – | ps |
| T_{FCLK} | Reference clock fall time | 80% – 20% | – | 200 | – | ps |
| T_{DCREF} | Reference clock duty cycle | Transceiver PLL only | 45 | 50 | 55 | % |
| T_{LOCK} | Clock recovery frequency acquisition time | Initial PLL lock | – | – | 1 | ms |
| T_{PHASE} | Clock recovery phase acquisition time | Lock to data after PLL has locked to the reference clock | – | – | 200 | μ s |

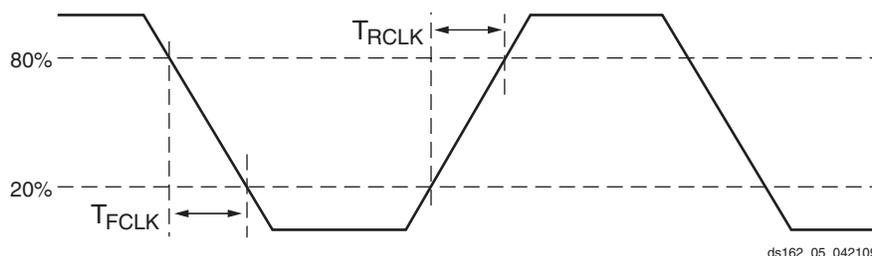


Figure 3: Reference Clock Timing Parameters

Table 21: GTP Transceiver User Clock Switching Characteristics⁽¹⁾

| Symbol | Description | Conditions | Speed Grade | | | | Units |
|--------------------|-----------------------------|------------------|-------------|--------|------|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| F _{TXOUT} | TXOUTCLK maximum frequency | | 320 | 320 | 270 | N/A | MHz |
| F _{RXREC} | RXRECCLK maximum frequency | | 320 | 320 | 270 | N/A | MHz |
| T _{RX} | RXUSRCLK maximum frequency | | 320 | 320 | 270 | N/A | MHz |
| T _{RX2} | RXUSRCLK2 maximum frequency | 1 byte interface | 156.25 | 156.25 | 125 | N/A | MHz |
| | | 2 byte interface | 160 | 160 | 125 | N/A | MHz |
| | | 4 byte interface | 80 | 80 | 67.5 | N/A | MHz |
| T _{TX} | TXUSRCLK maximum frequency | | 320 | 320 | 270 | N/A | MHz |
| T _{TX2} | TXUSRCLK2 maximum frequency | 1 byte interface | 156.25 | 156.25 | 125 | N/A | MHz |
| | | 2 byte interface | 160 | 160 | 125 | N/A | MHz |
| | | 4 byte interface | 80 | 80 | 67.5 | N/A | MHz |

Notes:

1. Clocking must be implemented as described in [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#).

Table 22: GTP Transceiver Transmitter Switching Characteristics

| Symbol | Description | Condition | Min | Typ | Max | Units |
|------------------------------|-------------------------------------|------------|-----|-----|------|-------|
| T _{RTX} | TX Rise time | 20%–80% | – | 140 | – | ps |
| T _{FTX} | TX Fall time | 80%–20% | – | 120 | – | ps |
| T _{LLSKEW} | TX lane-to-lane skew ⁽¹⁾ | | – | – | 400 | ps |
| V _{TXOOBVDPP} | Electrical idle amplitude | | – | – | 20 | mV |
| T _{TXOOBTRANSITION} | Electrical idle transition time | | – | – | 50 | ns |
| T _{J3.125} | Total Jitter ⁽²⁾ | 3.125 Gb/s | – | – | 0.35 | UI |
| D _{J3.125} | Deterministic Jitter ⁽²⁾ | | – | – | 0.15 | UI |
| T _{J2.5} | Total Jitter ⁽²⁾ | 2.5 Gb/s | – | – | 0.33 | UI |
| D _{J2.5} | Deterministic Jitter ⁽²⁾ | | – | – | 0.15 | UI |
| T _{J1.62} | Total Jitter ⁽²⁾ | 1.62 Gb/s | – | – | 0.20 | UI |
| D _{J1.62} | Deterministic Jitter ⁽²⁾ | | – | – | 0.10 | UI |
| T _{J1.25} | Total Jitter ⁽²⁾ | 1.25 Gb/s | – | – | 0.20 | UI |
| D _{J1.25} | Deterministic Jitter ⁽²⁾ | | – | – | 0.10 | UI |
| T _{J614} | Total Jitter ⁽²⁾ | 614 Mb/s | – | – | 0.10 | UI |
| D _{J614} | Deterministic Jitter ⁽²⁾ | | – | – | 0.05 | UI |

Notes:

1. Using same REFCLK input with TXENPMAPHASEALIGN enabled for up to four consecutive GTP transceiver sites.
2. Using PLL_DIVSEL_FB = 2, INTDATAWIDTH = 1. These values are NOT intended for protocol specific compliance determinations.

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

| I/O Standard | T _{IOPI} | | T _{IOOP} | | T _{IOTP} | | Units |
|---------------------------|-------------------|------|-------------------|------|-------------------|------|-------|
| | Speed Grade | | Speed Grade | | Speed Grade | | |
| | -3 | -2 | -3 | -2 | -3 | -2 | |
| DIFF_SSTL3_I | 1.26 | 1.44 | 1.95 | 2.15 | 1.95 | 2.15 | ns |
| DIFF_SSTL3_II | 1.26 | 1.44 | 1.94 | 2.14 | 1.94 | 2.14 | ns |
| DIFF_SSTL2_I | 1.09 | 1.27 | 1.94 | 2.14 | 1.94 | 2.14 | ns |
| DIFF_SSTL2_II | 1.09 | 1.27 | 1.90 | 2.10 | 1.90 | 2.10 | ns |
| DIFF_SSTL18_I | 1.04 | 1.22 | 1.86 | 2.06 | 1.86 | 2.06 | ns |
| DIFF_SSTL18_II | 1.05 | 1.23 | 1.82 | 2.02 | 1.82 | 2.02 | ns |
| DIFF_SSTL15_II | 1.01 | 1.19 | 1.81 | 2.01 | 1.81 | 2.01 | ns |
| DIFF_MOBILE_DDR | 1.04 | 1.22 | 1.89 | 2.09 | 1.89 | 2.09 | ns |
| LVTTL, QUIETIO, 2 mA | 1.42 | 1.60 | 5.64 | 5.84 | 5.64 | 5.84 | ns |
| LVTTL, QUIETIO, 4 mA | 1.42 | 1.60 | 4.46 | 4.66 | 4.46 | 4.66 | ns |
| LVTTL, QUIETIO, 6 mA | 1.42 | 1.60 | 3.92 | 4.12 | 3.92 | 4.12 | ns |
| LVTTL, QUIETIO, 8 mA | 1.42 | 1.60 | 3.37 | 3.57 | 3.37 | 3.57 | ns |
| LVTTL, QUIETIO, 12 mA | 1.42 | 1.60 | 3.42 | 3.62 | 3.42 | 3.62 | ns |
| LVTTL, QUIETIO, 16 mA | 1.42 | 1.60 | 3.09 | 3.29 | 3.09 | 3.29 | ns |
| LVTTL, QUIETIO, 24 mA | 1.42 | 1.60 | 2.83 | 3.03 | 2.83 | 3.03 | ns |
| LVTTL, Slow, 2 mA | 1.42 | 1.60 | 4.58 | 4.78 | 4.58 | 4.78 | ns |
| LVTTL, Slow, 4 mA | 1.42 | 1.60 | 3.38 | 3.58 | 3.38 | 3.58 | ns |
| LVTTL, Slow, 6 mA | 1.42 | 1.60 | 2.95 | 3.15 | 2.95 | 3.15 | ns |
| LVTTL, Slow, 8 mA | 1.42 | 1.60 | 2.73 | 2.93 | 2.73 | 2.93 | ns |
| LVTTL, Slow, 12 mA | 1.42 | 1.60 | 2.72 | 2.92 | 2.72 | 2.92 | ns |
| LVTTL, Slow, 16 mA | 1.42 | 1.60 | 2.53 | 2.73 | 2.53 | 2.73 | ns |
| LVTTL, Slow, 24 mA | 1.42 | 1.60 | 2.42 | 2.62 | 2.42 | 2.62 | ns |
| LVTTL, Fast, 2 mA | 1.42 | 1.60 | 4.04 | 4.24 | 4.04 | 4.24 | ns |
| LVTTL, Fast, 4 mA | 1.42 | 1.60 | 2.66 | 2.86 | 2.66 | 2.86 | ns |
| LVTTL, Fast, 6 mA | 1.42 | 1.60 | 2.58 | 2.78 | 2.58 | 2.78 | ns |
| LVTTL, Fast, 8 mA | 1.42 | 1.60 | 2.46 | 2.66 | 2.46 | 2.66 | ns |
| LVTTL, Fast, 12 mA | 1.42 | 1.60 | 1.97 | 2.17 | 1.97 | 2.17 | ns |
| LVTTL, Fast, 16 mA | 1.42 | 1.60 | 1.97 | 2.17 | 1.97 | 2.17 | ns |
| LVTTL, Fast, 24 mA | 1.42 | 1.60 | 1.97 | 2.17 | 1.97 | 2.17 | ns |
| LVC MOS33, QUIETIO, 2 mA | 1.41 | 1.59 | 5.65 | 5.85 | 5.65 | 5.85 | ns |
| LVC MOS33, QUIETIO, 4 mA | 1.41 | 1.59 | 4.20 | 4.40 | 4.20 | 4.40 | ns |
| LVC MOS33, QUIETIO, 6 mA | 1.41 | 1.59 | 3.65 | 3.85 | 3.65 | 3.85 | ns |
| LVC MOS33, QUIETIO, 8 mA | 1.41 | 1.59 | 3.51 | 3.71 | 3.51 | 3.71 | ns |
| LVC MOS33, QUIETIO, 12 mA | 1.41 | 1.59 | 3.09 | 3.29 | 3.09 | 3.29 | ns |
| LVC MOS33, QUIETIO, 16 mA | 1.41 | 1.59 | 2.91 | 3.11 | 2.91 | 3.11 | ns |
| LVC MOS33, QUIETIO, 24 mA | 1.41 | 1.59 | 2.73 | 2.93 | 2.73 | 2.93 | ns |
| LVC MOS33, Slow, 2 mA | 1.41 | 1.59 | 4.59 | 4.79 | 4.59 | 4.79 | ns |
| LVC MOS33, Slow, 4 mA | 1.41 | 1.59 | 3.14 | 3.34 | 3.14 | 3.34 | ns |

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

| I/O Standard | T _{IOPI} | | T _{IOOP} | | T _{IOTP} | | Units |
|---------------------------------|-------------------|------|-------------------|------|-------------------|------|-------|
| | Speed Grade | | Speed Grade | | Speed Grade | | |
| | -3 | -2 | -3 | -2 | -3 | -2 | |
| LVC MOS12, QUIETIO, 6 mA | 0.98 | 1.16 | 4.79 | 4.99 | 4.79 | 4.99 | ns |
| LVC MOS12, QUIETIO, 8 mA | 0.98 | 1.16 | 4.43 | 4.63 | 4.43 | 4.63 | ns |
| LVC MOS12, QUIETIO, 12 mA | 0.98 | 1.16 | 4.18 | 4.38 | 4.18 | 4.38 | ns |
| LVC MOS12, Slow, 2 mA | 0.98 | 1.16 | 5.12 | 5.32 | 5.12 | 5.32 | ns |
| LVC MOS12, Slow, 4 mA | 0.98 | 1.16 | 3.00 | 3.20 | 3.00 | 3.20 | ns |
| LVC MOS12, Slow, 6 mA | 0.98 | 1.16 | 2.91 | 3.11 | 2.91 | 3.11 | ns |
| LVC MOS12, Slow, 8 mA | 0.98 | 1.16 | 2.51 | 2.71 | 2.51 | 2.71 | ns |
| LVC MOS12, Slow, 12 mA | 0.98 | 1.16 | 2.25 | 2.45 | 2.25 | 2.45 | ns |
| LVC MOS12, Fast, 2 mA | 0.98 | 1.16 | 3.60 | 3.80 | 3.60 | 3.80 | ns |
| LVC MOS12, Fast, 4 mA | 0.98 | 1.16 | 2.49 | 2.69 | 2.49 | 2.69 | ns |
| LVC MOS12, Fast, 6 mA | 0.98 | 1.16 | 1.94 | 2.14 | 1.94 | 2.14 | ns |
| LVC MOS12, Fast, 8 mA | 0.98 | 1.16 | 1.82 | 2.02 | 1.82 | 2.02 | ns |
| LVC MOS12, Fast, 12 mA | 0.98 | 1.16 | 1.80 | 2.00 | 1.80 | 2.00 | ns |
| LVC MOS12_JEDEC, QUIETIO, 2 mA | 1.57 | 1.75 | 6.53 | 6.73 | 6.53 | 6.73 | ns |
| LVC MOS12_JEDEC, QUIETIO, 4 mA | 1.57 | 1.75 | 5.12 | 5.32 | 5.12 | 5.32 | ns |
| LVC MOS12_JEDEC, QUIETIO, 6 mA | 1.57 | 1.75 | 4.81 | 5.01 | 4.81 | 5.01 | ns |
| LVC MOS12_JEDEC, QUIETIO, 8 mA | 1.57 | 1.75 | 4.44 | 4.64 | 4.44 | 4.64 | ns |
| LVC MOS12_JEDEC, QUIETIO, 12 mA | 1.57 | 1.75 | 4.20 | 4.40 | 4.20 | 4.40 | ns |
| LVC MOS12_JEDEC, Slow, 2 mA | 1.57 | 1.75 | 5.14 | 5.34 | 5.14 | 5.34 | ns |
| LVC MOS12_JEDEC, Slow, 4 mA | 1.57 | 1.75 | 2.99 | 3.19 | 2.99 | 3.19 | ns |
| LVC MOS12_JEDEC, Slow, 6 mA | 1.57 | 1.75 | 2.90 | 3.10 | 2.90 | 3.10 | ns |
| LVC MOS12_JEDEC, Slow, 8 mA | 1.57 | 1.75 | 2.50 | 2.70 | 2.50 | 2.70 | ns |
| LVC MOS12_JEDEC, Slow, 12 mA | 1.57 | 1.75 | 2.26 | 2.46 | 2.26 | 2.46 | ns |
| LVC MOS12_JEDEC, Fast, 2 mA | 1.57 | 1.75 | 3.60 | 3.80 | 3.60 | 3.80 | ns |
| LVC MOS12_JEDEC, Fast, 4 mA | 1.57 | 1.75 | 2.49 | 2.69 | 2.49 | 2.69 | ns |
| LVC MOS12_JEDEC, Fast, 6 mA | 1.57 | 1.75 | 1.94 | 2.14 | 1.94 | 2.14 | ns |
| LVC MOS12_JEDEC, Fast, 8 mA | 1.57 | 1.75 | 1.83 | 2.03 | 1.83 | 2.03 | ns |
| LVC MOS12_JEDEC, Fast, 12 mA | 1.57 | 1.75 | 1.80 | 2.00 | 1.80 | 2.00 | ns |

Notes:

1. The Spartan-6Q FPGA -1L values are listed in Table 28.

Table 30 summarizes the value of T_{IOTPHZ}. T_{IOTPHZ} is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is enabled (i.e., a high impedance state). These delays are measured using LVC MOS25, Fast, 12 mA.

Table 30: IOB 3-state ON Output Switching Characteristics (T_{IOTPHZ})

| Symbol | Description | Speed Grade | | | | Units |
|---------------------|-------------------------------|-------------|------|------|------|-------|
| | | -3 | -3N | -2 | -1L | |
| T _{IOTPHZ} | T input to Pad high-impedance | 1.39 | 1.59 | 1.59 | 1.91 | ns |

Input/Output Logic Switching Characteristics

Table 35: ILOGIC2 Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|--------------------------|--|----------------|----------------|----------------|----------------|-------|
| | | -3 | -3N | -2 | -1L | |
| Setup/Hold | | | | | | |
| T_{ICE0CK}/T_{ICKCE0} | CE0 pin Setup/Hold with respect to CLK | 0.56/ -0.30 | 0.56/ -0.25 | 0.79/ -0.22 | 1.21/ -0.52 | ns |
| T_{ISRCK}/T_{ICKSR} | SR pin Setup/Hold with respect to CLK | 0.74/ -0.23 | 0.74/ -0.22 | 0.98/ -0.20 | 1.31/ -0.45 | ns |
| T_{IDOCK}/T_{IOCKD} | D pin Setup/Hold with respect to CLK without Delay | 1.19/ -0.83 | 1.36/ -0.83 | 1.73/ -0.83 | 2.18/ -1.77 | ns |
| T_{IDOCKD}/T_{IOCKDD} | DDLY pin Setup/Hold with respect to CLK (using IODELAY2) | 0.31/ 0.00 | 0.47/ 0.00 | 0.54/ 0.00 | 0.63/ -0.39 | ns |
| Combinatorial | | | | | | |
| T_{IDI} | D pin to O pin propagation delay, no Delay | 0.95 | 1.28 | 1.53 | 2.25 | ns |
| T_{IDID} | DDLY pin to O pin propagation delay (using IODELAY2) | 0.23 | 0.39 | 0.44 | 0.74 | ns |
| Sequential Delays | | | | | | |
| T_{IDLO} | D pin to Q pin using flip-flop as a latch without Delay | 1.56 | 1.86 | 2.39 | 3.49 | ns |
| T_{IDLOD} | DDLY pin to Q1 pin using flip-flop as a latch (using IODELAY2) | 0.68 | 0.97 | 1.20 | 1.94 | ns |
| T_{ICKQ} | CLK to Q outputs for XC devices | 1.03 | 1.24 | 1.43 | 2.11 | ns |
| | CLK to Q outputs for XA and XQ devices | 1.38 | N/A | 1.78 | 2.11 | ns |
| $T_{RQ_ILOGIC2}$ | SR pin to Q outputs | 1.81 | 1.81 | 2.50 | 3.05 | ns |

Table 36: OLOGIC2 Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|--------------------------|---|----------------|----------------|----------------|----------------|-------|
| | | -3 | -3N | -2 | -1L | |
| Setup/Hold | | | | | | |
| T_{ODCK}/T_{OOCKD} | D1/D2 pins Setup/Hold with respect to CLK | 0.81/ -0.05 | 0.86/ -0.05 | 1.18/ 0.00 | 1.73/ -0.27 | ns |
| $T_{OOCECK}/T_{OOCKOCE}$ | OCE pin Setup/Hold with respect to CLK | 0.75/ -0.10 | 0.75/ -0.10 | 1.01/ -0.05 | 1.66/ -0.23 | ns |
| T_{OSRCK}/T_{OOCKSR} | SR pin Setup/Hold with respect to CLK | 0.70/ -0.28 | 0.79/ -0.28 | 1.03/ -0.23 | 1.39/ -0.47 | ns |
| T_{OTCK}/T_{OOCKT} | T1/T2 pins Setup/Hold with respect to CLK | 0.24/ -0.08 | 0.56/ -0.06 | 0.83/ -0.01 | 0.99/ -0.19 | ns |
| $T_{OTCECK}/T_{OOCKTCE}$ | TCE pin Setup/Hold with respect to CLK | 0.58/ -0.06 | 0.72/ -0.06 | 1.18/ -0.01 | 1.51/ -0.13 | ns |
| Sequential Delays | | | | | | |
| T_{OOCKQ} | CLK to OQ/TQ out for XC devices | 0.48 | 0.51 | 0.74 | 0.74 | ns |
| | CLK to OQ/TQ out for XA and XQ devices | 0.85 | N/A | 1.16 | 0.74 | ns |
| $T_{RQ_OLOGIC2}$ | SR pin to OQ/TQ out | 1.81 | 1.81 | 2.50 | 3.05 | ns |

CLB Distributed RAM Switching Characteristics (SLICEM Only)

Table 41: CLB Distributed RAM Switching Characteristics (SLICEM Only)

| Symbol | Description | Speed Grade | | | | Units |
|--|--|----------------|----------------|----------------|----------------|---------|
| | | -3 | -3N | -2 | -1L | |
| Sequential Delays | | | | | | |
| T _{SHCKO} | Clock to A – D outputs | 1.26 | 1.55 | 1.55 | 2.35 | ns, Max |
| | Clock to A – D outputs (direct output path) | 0.96 | 1.20 | 1.20 | 1.87 | ns, Max |
| Setup and Hold Times Before/After Clock CLK | | | | | | |
| T _{DS} /T _{DH} | AX – DX or AI – DI inputs to CLK | 0.59/ 0.17 | 0.73/ 0.22 | 0.73/ 0.22 | 1.17/ 0.33 | ns, Min |
| T _{AS} /T _{AH} | Address An inputs to clock for XC devices | 0.28/ 0.35 | 0.32/ 0.42 | 0.32/ 0.42 | 0.26/ 0.71 | ns, Min |
| | Address An inputs to clock for XA and XQ devices | 0.28/ 0.51 | N/A | 0.32/ 0.51 | 0.26/ 0.71 | ns, Min |
| T _{WS} /T _{WH} | WE input to clock | 0.31/ –0.08 | 0.37/ –0.08 | 0.37/ –0.08 | 0.59/ –0.27 | ns, Min |
| T _{CECK} /T _{CKCE} | CE input to CLK | 0.31/ –0.08 | 0.37/ –0.08 | 0.37/ –0.08 | 0.59/ –0.27 | ns, Min |

CLB Shift Register Switching Characteristics (SLICEM Only)

Table 42: CLB Shift Register Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|--|---|----------------|----------------|----------------|----------------|---------|
| | | -3 | -3N | -2 | -1L | |
| Sequential Delays | | | | | | |
| T _{REG} | Clock to A – D outputs | 1.35 | 1.78 | 1.78 | 2.74 | ns, Max |
| | Clock to A – D outputs (direct output path) | 1.24 | 1.65 | 1.65 | 2.48 | ns, Max |
| Setup and Hold Times Before/After Clock CLK | | | | | | |
| T _{WS} /T _{WH} | WE input to CLK | 0.20/ –0.07 | 0.24/ –0.07 | 0.24/ –0.07 | 0.29/ –0.27 | ns, Min |
| T _{CECK} /T _{CKCE} | CE input to CLK for XC devices | 0.30/ 0.30 | 0.30/ 0.38 | 0.30/ 0.38 | 0.82/ –0.41 | ns, Min |
| | CE input to CLK for XA and XQ devices | 0.32/ 0.30 | N/A | 0.40/ 0.38 | 0.82/ –0.41 | ns, Min |
| T _{DS} /T _{DH} | AX – DX or AI – DI inputs to CLK | 0.07/ 0.11 | 0.09/ 0.14 | 0.09/ 0.14 | 0.11/ 0.23 | ns, Min |

Table 54: Switching Characteristics for the Delay-Locked Loop (DLL)⁽¹⁾ (Cont'd)

| Symbol | Description | Speed Grade | | | | | | | | Units |
|-------------------------------|--|-------------|------|-----|------|-----|------|-----|------|-------|
| | | -3 | | -3N | | -2 | | -1L | | |
| | | Min | Max | Min | Max | Min | Max | Min | Max | |
| LOCK_DLL ⁽³⁾ | When using the DLL alone: The time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. When the DCM is locked, the CLKIN and CLKFB signals are in phase. CLKIN_FREQ_DLL < 50 MHz. | - | 5 | - | 5 | - | 5 | - | 5 | ms |
| | When using the DLL alone: The time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. When the DCM is locked, the CLKIN and CLKFB signals are in phase. CLKIN_FREQ_DLL > 50 MHz | - | 0.60 | - | 0.60 | - | 0.60 | - | 0.60 | ms |
| Delay Lines | | | | | | | | | | |
| DCM_DELAY_STEP ⁽⁵⁾ | Finest delay resolution, averaged over all steps. | 10 | 40 | 10 | 40 | 10 | 40 | 10 | 40 | ps |

Notes:

1. The values in this table are based on the operating conditions described in Table 2 and Table 53.
2. Indicates the maximum amount of output jitter that the DCM adds to the jitter on the CLKIN input.
3. For optimal jitter tolerance and faster LOCK time, use the CLKIN_PERIOD attribute.
4. Some jitter and duty-cycle specifications include 1% of input clock period or 0.01 UI. For example, this data sheet specifies a maximum jitter of ±(1% of CLKIN period + 150 ps). Assuming that the CLKIN frequency is 100 MHz, the equivalent CLKIN period is 10 ns. Since 1% of 10 ns is 0.1 ns or 100 ps, the maximum jitter is ±(100 ps + 150 ps) = ±250 ps.
5. A typical delay step size is 23 ps.
6. The timing analysis tools use the CLK_FEEDBACK = 1X condition for the CLKIN_CLKFB_PHASE value (reported as phase error). When using CLK_FEEDBACK = 2X, add 100 ps to the phase error for the CLKIN_CLKFB_PHASE value (as shown in this table).

Table 55: Recommended Operating Conditions for the Digital Frequency Synthesizer (DFS)⁽¹⁾

| Symbol | Description | Speed Grade | | | | | | | | Units |
|---|--|-------------|--------------------|-----|--------------------|-----|--------------------|-----|--------------------|-------|
| | | -3 | | -3N | | -2 | | -1L | | |
| | | Min | Max | Min | Max | Min | Max | Min | Max | |
| Input Frequency Ranges⁽²⁾ | | | | | | | | | | |
| CLKIN_FREQ_FX | Frequency for the CLKIN input. Also described as F _{CLKIN} . | 0.5 | 375 ⁽³⁾ | 0.5 | 375 ⁽³⁾ | 0.5 | 333 ⁽³⁾ | 0.5 | 200 ⁽³⁾ | MHz |
| Input Clock Jitter Tolerance⁽⁴⁾ | | | | | | | | | | |
| CLKIN_CYC_JITT_FX_LF | Cycle-to-cycle jitter at the CLKIN input, based on CLKFX output frequency: F _{CLKFX} < 150 MHz. | - | ±300 | - | ±300 | - | ±300 | - | ±300 | ps |
| CLKIN_CYC_JITT_FX_HF | Cycle-to-cycle jitter at the CLKIN input, based on CLKFX output frequency: F _{CLKFX} > 150 MHz. | - | ±150 | - | ±150 | - | ±150 | - | ±150 | ps |
| CLKIN_PER_JITT_FX | Period jitter at the CLKIN input. | - | ±1 | - | ±1 | - | ±1 | - | ±1 | ns |

Notes:

1. DFS specifications apply when using either of the DFS outputs (CLKFX or CLKFX180).
2. When using both DFS and DLL outputs on the same DCM, follow the more restrictive CLKIN_FREQ_DLL specifications in Table 53.
3. The CLKIN_DIVIDE_BY_2 attribute increases the effective input frequency range. When set to TRUE, the input clock frequency is divided by two as it enters the DCM. Input clock frequencies for the clock buffer being used can be increased up to the F_{MAX} (see Table 48 and Table 49 for BUFIO2 and BUFG2 limits).
4. CLKIN input jitter beyond these limits can cause the DCM to lose LOCK.

Spartan-6 Device Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. The representative values for typical pin locations and normal clock loading are listed in [Table 63](#) through [Table 69](#). Values are expressed in nanoseconds unless otherwise noted.

Table 63: Global Clock Input to Output Delay Without DCM or PLL

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|-------|------|-------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>without</i> DCM or PLL | | | | | | | |
| T _{ICKOF} | Global Clock and OUTFF <i>without</i> DCM or PLL | XC6SLX4 | 6.12 | N/A | 7.68 | 9.41 | ns |
| | | XC6SLX9 | 6.12 | 6.51 | 7.68 | 9.41 | ns |
| | | XC6SLX16 | 5.98 | 6.42 | 7.48 | 9.10 | ns |
| | | XC6SLX25 | 6.20 | 6.69 | 7.84 | 9.44 | ns |
| | | XC6SLX25T | 6.20 | 6.69 | 7.84 | N/A | ns |
| | | XC6SLX45 | 6.37 | 6.88 | 8.10 | 9.61 | ns |
| | | XC6SLX45T | 6.37 | 6.88 | 8.10 | N/A | ns |
| | | XC6SLX75 | 6.39 | 6.99 | 8.16 | 10.18 | ns |
| | | XC6SLX75T | 6.39 | 6.99 | 8.16 | N/A | ns |
| | | XC6SLX100 | 6.59 | 7.18 | 8.41 | 10.31 | ns |
| | | XC6SLX100T | 6.59 | 7.18 | 8.41 | N/A | ns |
| | | XC6SLX150 | 6.98 | 7.68 | 8.80 | 10.62 | ns |
| | | XC6SLX150T | 6.98 | 7.68 | 8.80 | N/A | ns |
| | | XA6SLX4 | 6.44 | N/A | 7.68 | N/A | ns |
| | | XA6SLX9 | 6.44 | N/A | 7.68 | N/A | ns |
| | | XA6SLX16 | 6.30 | N/A | 7.48 | N/A | ns |
| | | XA6SLX25 | 6.52 | N/A | 7.84 | N/A | ns |
| | | XA6SLX25T | 6.52 | N/A | 7.84 | N/A | ns |
| | | XA6SLX45 | 6.69 | N/A | 8.12 | N/A | ns |
| | | XA6SLX45T | 6.69 | N/A | 8.12 | N/A | ns |
| | | XA6SLX75 | 6.89 | N/A | 8.16 | N/A | ns |
| | | XA6SLX75T | 6.89 | N/A | 8.16 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 8.36 | N/A | ns |
| XQ6SLX75 | N/A | N/A | 8.16 | 10.18 | ns | | |
| XQ6SLX75T | 6.89 | N/A | 8.16 | N/A | ns | | |
| XQ6SLX150 | N/A | N/A | 8.80 | 10.62 | ns | | |
| XQ6SLX150T | 7.61 | N/A | 8.80 | N/A | ns | | |

Notes:

- Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.

Table 65: Global Clock Input to Output Delay With DCM in Source-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|--|---------------------------------|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, with DCM in Source-Synchronous Mode. | | | | | | | |
| T _{ICKOFDCM_0} | Global Clock and OUTFF with DCM | XC6SLX4 | 5.03 | N/A | 7.21 | 8.05 | ns |
| | | XC6SLX9 | 5.03 | 6.13 | 7.21 | 8.05 | ns |
| | | XC6SLX16 | 5.08 | 5.51 | 6.44 | 7.96 | ns |
| | | XC6SLX25 | 4.81 | 5.13 | 5.69 | 7.94 | ns |
| | | XC6SLX25T | 4.81 | 5.13 | 5.69 | N/A | ns |
| | | XC6SLX45 | 5.26 | 5.69 | 6.63 | 7.92 | ns |
| | | XC6SLX45T | 5.26 | 5.69 | 6.63 | N/A | ns |
| | | XC6SLX75 | 4.77 | 5.18 | 5.88 | 7.95 | ns |
| | | XC6SLX75T | 4.77 | 5.18 | 5.88 | N/A | ns |
| | | XC6SLX100 | 4.72 | 5.11 | 5.76 | 8.59 | ns |
| | | XC6SLX100T | 4.76 | 5.11 | 5.76 | N/A | ns |
| | | XC6SLX150 | 4.90 | 5.30 | 5.93 | 7.93 | ns |
| | | XC6SLX150T | 4.90 | 5.30 | 5.93 | N/A | ns |
| | | XA6SLX4 | 5.35 | N/A | 7.21 | N/A | ns |
| | | XA6SLX9 | 5.35 | N/A | 7.21 | N/A | ns |
| | | XA6SLX16 | 5.42 | N/A | 6.44 | N/A | ns |
| | | XA6SLX25 | 5.13 | N/A | 5.69 | N/A | ns |
| | | XA6SLX25T | 5.13 | N/A | 5.79 | N/A | ns |
| | | XA6SLX45 | 5.58 | N/A | 6.63 | N/A | ns |
| | | XA6SLX45T | 5.58 | N/A | 6.63 | N/A | ns |
| | | XA6SLX75 | 5.09 | N/A | 5.87 | N/A | ns |
| | | XA6SLX75T | 5.09 | N/A | 5.87 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 6.44 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 5.87 | 7.95 | ns |
| | | XQ6SLX75T | 5.09 | N/A | 5.87 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 6.06 | 7.93 | ns |
| XQ6SLX150T | 5.50 | N/A | 6.06 | N/A | ns | | |

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM output jitter is already included in the timing calculation.

Table 66: Global Clock Input to Output Delay With PLL in System-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|--|---------------------------------|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, with PLL in System-Synchronous Mode. | | | | | | | |
| T _{ICKOFFPLL} | Global Clock and OUTFF with PLL | XC6SLX4 | 4.57 | N/A | 6.25 | 7.34 | ns |
| | | XC6SLX9 | 4.57 | 5.25 | 6.25 | 7.34 | ns |
| | | XC6SLX16 | 4.41 | 4.64 | 5.39 | 6.92 | ns |
| | | XC6SLX25 | 4.03 | 4.32 | 4.91 | 7.64 | ns |
| | | XC6SLX25T | 4.03 | 4.32 | 4.91 | N/A | ns |
| | | XC6SLX45 | 4.63 | 4.96 | 5.75 | 7.36 | ns |
| | | XC6SLX45T | 4.63 | 4.96 | 5.75 | N/A | ns |
| | | XC6SLX75 | 4.01 | 4.30 | 4.88 | 7.15 | ns |
| | | XC6SLX75T | 4.01 | 4.30 | 4.88 | N/A | ns |
| | | XC6SLX100 | 4.02 | 4.33 | 4.90 | 7.37 | ns |
| | | XC6SLX100T | 4.06 | 4.33 | 4.90 | N/A | ns |
| | | XC6SLX150 | 3.65 | 3.98 | 4.58 | 6.94 | ns |
| | | XC6SLX150T | 3.65 | 3.98 | 4.58 | N/A | ns |
| | | XA6SLX4 | 4.88 | N/A | 6.13 | N/A | ns |
| | | XA6SLX9 | 4.88 | N/A | 6.13 | N/A | ns |
| | | XA6SLX16 | 4.74 | N/A | 5.27 | N/A | ns |
| | | XA6SLX25 | 4.43 | N/A | 4.78 | N/A | ns |
| | | XA6SLX25T | 4.43 | N/A | 4.88 | N/A | ns |
| | | XA6SLX45 | 4.94 | N/A | 5.62 | N/A | ns |
| | | XA6SLX45T | 4.94 | N/A | 5.62 | N/A | ns |
| | | XA6SLX75 | 4.32 | N/A | 4.77 | N/A | ns |
| | | XA6SLX75T | 4.32 | N/A | 4.77 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 5.41 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 4.77 | 7.15 | ns |
| XQ6SLX75T | 4.32 | N/A | 4.77 | N/A | ns | | |
| XQ6SLX150 | N/A | N/A | 4.60 | 6.94 | ns | | |
| XQ6SLX150T | 4.35 | N/A | 4.60 | N/A | ns | | |

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. PLL output jitter is included in the timing calculation.

Table 67: Global Clock Input to Output Delay With PLL in Source-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> PLL in Source-Synchronous Mode. | | | | | | | |
| T _{ICKOFFLL_0} | Global Clock and OUTFF <i>with</i> PLL | XC6SLX4 | 5.49 | N/A | 7.44 | 8.55 | ns |
| | | XC6SLX9 | 5.49 | 6.29 | 7.44 | 8.55 | ns |
| | | XC6SLX16 | 5.23 | 5.77 | 6.79 | 8.21 | ns |
| | | XC6SLX25 | 5.00 | 5.35 | 6.10 | 8.54 | ns |
| | | XC6SLX25T | 5.00 | 5.35 | 6.10 | N/A | ns |
| | | XC6SLX45 | 5.59 | 6.03 | 7.02 | 8.39 | ns |
| | | XC6SLX45T | 5.59 | 6.03 | 7.02 | N/A | ns |
| | | XC6SLX75 | 4.96 | 5.41 | 6.22 | 8.32 | ns |
| | | XC6SLX75T | 4.96 | 5.41 | 6.22 | N/A | ns |
| | | XC6SLX100 | 4.97 | 5.42 | 6.21 | 9.08 | ns |
| | | XC6SLX100T | 5.01 | 5.42 | 6.21 | N/A | ns |
| | | XC6SLX150 | 4.59 | 5.06 | 5.86 | 8.13 | ns |
| | | XC6SLX150T | 4.59 | 5.06 | 5.86 | N/A | ns |
| | | XA6SLX4 | 5.79 | N/A | 7.32 | N/A | ns |
| | | XA6SLX9 | 5.79 | N/A | 7.32 | N/A | ns |
| | | XA6SLX16 | 5.56 | N/A | 6.66 | N/A | ns |
| | | XA6SLX25 | 5.40 | N/A | 5.97 | N/A | ns |
| | | XA6SLX25T | 5.40 | N/A | 6.07 | N/A | ns |
| | | XA6SLX45 | 5.89 | N/A | 6.90 | N/A | ns |
| | | XA6SLX45T | 5.89 | N/A | 6.90 | N/A | ns |
| | | XA6SLX75 | 5.27 | N/A | 6.12 | N/A | ns |
| | | XA6SLX75T | 5.27 | N/A | 6.12 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 6.80 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 6.12 | 8.32 | ns |
| | | XQ6SLX75T | 5.27 | N/A | 6.12 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 5.88 | 8.13 | ns |
| XQ6SLX150T | 5.21 | N/A | 5.88 | N/A | ns | | |

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. PLL output jitter is included in the timing calculation.

Table 69: Global Clock Input to Output Delay With DCM and PLL in Source-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|--|---|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, with DCM in Source-Synchronous Mode and PLL in DCM2PLL Mode. | | | | | | | |
| T _{ICKOFDCM0_PLL} | Global Clock and OUTFF with DCM and PLL | XC6SLX4 | 5.58 | N/A | 7.42 | 8.54 | ns |
| | | XC6SLX9 | 5.58 | 6.19 | 7.42 | 8.54 | ns |
| | | XC6SLX16 | 5.50 | 6.06 | 7.05 | 8.24 | ns |
| | | XC6SLX25 | 5.57 | 6.04 | 7.02 | 8.33 | ns |
| | | XC6SLX25T | 5.57 | 6.04 | 7.02 | N/A | ns |
| | | XC6SLX45 | 5.53 | 5.97 | 6.96 | 8.32 | ns |
| | | XC6SLX45T | 5.53 | 5.97 | 6.96 | N/A | ns |
| | | XC6SLX75 | 5.55 | 6.00 | 6.99 | 8.54 | ns |
| | | XC6SLX75T | 5.55 | 6.00 | 6.99 | N/A | ns |
| | | XC6SLX100 | 5.58 | 6.03 | 7.02 | 9.11 | ns |
| | | XC6SLX100T | 5.62 | 6.03 | 7.02 | N/A | ns |
| | | XC6SLX150 | 5.32 | 5.70 | 6.41 | 8.26 | ns |
| | | XC6SLX150T | 5.32 | 5.70 | 6.41 | N/A | ns |
| | | XA6SLX4 | 5.87 | N/A | 7.28 | N/A | ns |
| | | XA6SLX9 | 5.87 | N/A | 7.28 | N/A | ns |
| | | XA6SLX16 | 6.02 | N/A | 6.87 | N/A | ns |
| | | XA6SLX25 | 5.88 | N/A | 6.90 | N/A | ns |
| | | XA6SLX25T | 5.88 | N/A | 7.00 | N/A | ns |
| | | XA6SLX45 | 5.82 | N/A | 6.81 | N/A | ns |
| | | XA6SLX45T | 5.82 | N/A | 6.81 | N/A | ns |
| | | XA6SLX75 | 5.81 | N/A | 6.80 | N/A | ns |
| | | XA6SLX75T | 5.81 | N/A | 6.80 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 6.88 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 6.80 | 8.54 | ns |
| XQ6SLX75T | 5.81 | N/A | 6.80 | N/A | ns | | |
| XQ6SLX150 | N/A | N/A | 6.41 | 8.26 | ns | | |
| XQ6SLX150T | 5.90 | N/A | 6.41 | N/A | ns | | |

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM and PLL output jitter are already included in the timing calculation.

Table 73: Global Clock Setup and Hold With DCM in Source-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|--|--|------------|-------------|-----------|-----------|-----------|-------|
| | | | -3 | -3N | -2 | -1L | |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVC MOS25 Standard.⁽¹⁾ | | | | | | | |
| T _{PSDCMO} / T _{PHDCMO} | No Delay Global Clock and IFF ⁽²⁾ with DCM in Source-Synchronous Mode | XC6SLX4 | 0.71/0.65 | N/A | 0.72/1.22 | 1.58/1.18 | ns |
| | | XC6SLX9 | 0.71/0.69 | 0.71/1.19 | 0.72/1.36 | 1.58/1.18 | ns |
| | | XC6SLX16 | 0.86/0.52 | 0.92/0.57 | 1.04/0.60 | 1.02/1.06 | ns |
| | | XC6SLX25 | 0.84/0.58 | 0.90/0.59 | 1.01/0.59 | 1.58/1.07 | ns |
| | | XC6SLX25T | 0.84/0.58 | 0.90/0.59 | 1.01/0.59 | N/A | ns |
| | | XC6SLX45 | 0.85/0.70 | 0.90/0.76 | 0.98/0.79 | 1.34/1.34 | ns |
| | | XC6SLX45T | 0.85/0.70 | 0.90/0.76 | 0.98/0.79 | N/A | ns |
| | | XC6SLX75 | 1.00/0.62 | 1.06/0.63 | 1.15/0.63 | 1.65/1.46 | ns |
| | | XC6SLX75T | 1.00/0.71 | 1.06/0.72 | 1.15/0.72 | N/A | ns |
| | | XC6SLX100 | 0.81/0.68 | 0.81/0.69 | 0.94/0.69 | 1.42/2.07 | ns |
| | | XC6SLX100T | 0.81/0.68 | 0.81/0.69 | 0.94/0.69 | N/A | ns |
| | | XC6SLX150 | 0.68/0.98 | 0.69/0.99 | 0.79/0.99 | 1.45/1.60 | ns |
| | | XC6SLX150T | 0.68/0.98 | 0.69/0.99 | 0.79/0.99 | N/A | ns |
| | | XA6SLX4 | 0.81/0.74 | N/A | 0.72/1.36 | N/A | ns |
| | | XA6SLX9 | 0.81/0.74 | N/A | 0.72/1.36 | N/A | ns |
| | | XA6SLX16 | 1.01/0.56 | N/A | 1.04/0.60 | N/A | ns |
| | | XA6SLX25 | 0.94/0.76 | N/A | 1.06/0.77 | N/A | ns |
| | | XA6SLX25T | 0.94/0.76 | N/A | 1.14/0.77 | N/A | ns |
| | | XA6SLX45 | 0.86/0.74 | N/A | 0.98/0.78 | N/A | ns |
| | | XA6SLX45T | 0.86/0.74 | N/A | 0.98/0.78 | N/A | ns |
| | | XA6SLX75 | 1.02/0.71 | N/A | 1.15/0.72 | N/A | ns |
| | | XA6SLX75T | 1.02/0.71 | N/A | 1.15/0.72 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 1.37/0.75 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 1.15/0.72 | 1.65/1.46 | ns |
| | | XQ6SLX75T | 1.02/0.71 | N/A | 1.15/0.72 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 0.79/1.15 | 1.45/1.60 | ns |
| XQ6SLX150T | 0.73/1.15 | N/A | 0.79/1.15 | N/A | ns | | |

Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include DCM CLK0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Table 77: Global Clock Setup and Hold With DCM and PLL in Source-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|---|------------|-------------|-----------|-----------|-----------|-------|
| | | | -3 | -3N | -2 | -1L | |
| Example Data Input Set-Up and Hold Times Relative to a Forwarded Clock Input Pin, ⁽¹⁾ Using DCM, PLL, and Global Clock Buffer for the LVCMOS25 standard. | | | | | | | |
| T _{PSDCMPLL_0} / T _{PHDCMPLL_0} | No Delay Global Clock and IFF ⁽²⁾ with DCM in Source-Synchronous Mode and PLL in DCM2PLL Mode. | XC6SLX4 | 0.43/1.07 | N/A | 0.43/1.43 | 1.10/1.67 | ns |
| | | XC6SLX9 | 0.43/1.03 | 0.45/1.14 | 0.45/1.43 | 1.10/1.67 | ns |
| | | XC6SLX16 | 0.74/0.93 | 0.74/1.12 | 0.74/1.21 | 0.77/1.35 | ns |
| | | XC6SLX25 | 0.67/1.02 | 0.76/1.11 | 0.84/1.18 | 1.23/1.46 | ns |
| | | XC6SLX25T | 0.67/1.02 | 0.76/1.11 | 0.84/1.18 | N/A | ns |
| | | XC6SLX45 | 0.65/0.99 | 0.65/1.04 | 0.71/1.12 | 1.18/1.58 | ns |
| | | XC6SLX45T | 0.65/1.00 | 0.65/1.04 | 0.71/1.12 | N/A | ns |
| | | XC6SLX75 | 0.86/1.01 | 0.88/1.06 | 0.94/1.14 | 1.29/1.67 | ns |
| | | XC6SLX75T | 0.86/1.01 | 0.88/1.06 | 0.94/1.14 | N/A | ns |
| | | XC6SLX100 | 0.50/1.10 | 0.56/1.10 | 0.61/1.17 | 0.84/2.24 | ns |
| | | XC6SLX100T | 0.50/1.10 | 0.56/1.10 | 0.61/1.17 | N/A | ns |
| | | XC6SLX150 | 0.45/1.28 | 0.47/1.28 | 0.52/1.28 | 1.27/1.56 | ns |
| | | XC6SLX150T | 0.45/1.28 | 0.47/1.28 | 0.52/1.28 | N/A | ns |
| | | XA6SLX4 | 0.74/1.00 | N/A | 0.74/1.43 | N/A | ns |
| | | XA6SLX9 | 0.74/1.00 | N/A | 0.74/1.43 | N/A | ns |
| | | XA6SLX16 | 1.81/1.15 | N/A | 1.81/1.03 | N/A | ns |
| | | XA6SLX25 | 0.89/1.01 | N/A | 0.96/1.05 | N/A | ns |
| | | XA6SLX25T | 0.89/1.01 | N/A | 1.04/1.15 | N/A | ns |
| | | XA6SLX45 | 0.69/0.95 | N/A | 0.83/0.96 | N/A | ns |
| | | XA6SLX45T | 0.69/0.95 | N/A | 0.83/0.96 | N/A | ns |
| | | XA6SLX75 | 0.88/0.94 | N/A | 1.06/0.96 | N/A | ns |
| | | XA6SLX75T | 0.88/0.94 | N/A | 1.06/0.96 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 1.55/1.33 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 1.06/0.96 | 1.29/1.67 | ns |
| XQ6SLX75T | 0.88/0.94 | N/A | 1.06/0.96 | N/A | ns | | |
| XQ6SLX150 | N/A | N/A | 0.64/1.30 | 1.27/1.56 | ns | | |
| XQ6SLX150T | 0.58/1.30 | N/A | 0.64/1.30 | N/A | ns | | |

Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. The timing values were measured using the fine-phase adjustment feature of the DCM. These measurements include CMT jitter; DCM CLK0 driving PLL, PLL CLKOUT0 driving BUFG. Package skew is not included in these measurements.
2. IFF = Input Flip-Flop

Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Spartan-6 FPGA source-synchronous transmitter and receiver data-valid windows.

Table 78: Duty Cycle Distortion and Clock-Tree Skew

| Symbol | Description | Device ⁽¹⁾ | Speed Grade | | | | Units |
|--------------------------|--|-----------------------|---------------------------------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| T _{DCD_CLK} | Global Clock Tree Duty Cycle Distortion ⁽²⁾ | LX4 | 0.20 | N/A | 0.20 | 0.35 | ns |
| | | LX9 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX16 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX25 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX25T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX45 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX45T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX75 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX75T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX100 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX100T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX150 | 0.35 | 0.35 | 0.35 | 0.35 | ns |
| | | LX150T | 0.35 | 0.35 | 0.35 | N/A | ns |
| | | T _{CKSKEW} | Global Clock Tree Skew ⁽³⁾ | LX4 | 0.25 | N/A | 0.25 |
| LX9 | 0.25 | | | 0.25 | 0.25 | 0.29 | ns |
| LX16 | 0.15 | | | 0.15 | 0.15 | 0.22 | ns |
| LX25 | 0.26 | | | 0.26 | 0.26 | 0.41 | ns |
| LX25T | 0.26 | | | 0.26 | 0.26 | N/A | ns |
| LX45 | 0.20 | | | 0.20 | 0.20 | 0.28 | ns |
| LX45T | 0.20 | | | 0.20 | 0.20 | N/A | ns |
| LX75 | 0.56 | | | 0.56 | 0.56 | 0.50 | ns |
| LX75T | 0.56 | | | 0.56 | 0.56 | N/A | ns |
| XC6SLX100 ⁽⁴⁾ | 0.22 | | | 0.22 | 0.22 | 0.21 | ns |
| XA6SLX100 ⁽⁴⁾ | N/A | | | N/A | 0.43 | N/A | ns |
| LX100T | 0.22 | | | 0.22 | 0.22 | N/A | ns |
| LX150 | 0.48 | | | 0.48 | 0.48 | 0.35 | ns |
| LX150T | 0.48 | | | 0.48 | 0.48 | N/A | ns |
| T _{DCD_BUFIO2} | I/O clock tree duty cycle distortion | LX devices | 0.25 | 0.25 | 0.25 | 0.50 | ns |
| | | LXT devices | 0.25 | 0.25 | 0.25 | N/A | ns |

Table 78: Duty Cycle Distortion and Clock-Tree Skew (Cont'd)

| Symbol | Description | Device ⁽¹⁾ | Speed Grade | | | | Units |
|------------------------|---|-----------------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| T _{BUFIOSKEW} | I/O clock tree skew across one clock region | LX4 | 0.06 | N/A | 0.06 | 0.07 | ns |
| | | LX9 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX16 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX25 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX25T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX45 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX45T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX75 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX75T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX100 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX100T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX150 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX150T | 0.06 | 0.06 | 0.06 | N/A | ns |

Notes:

- LXT devices are not available with a -1L speed grade. The LX4 is not available in -3N speed grade.
- These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
- The T_{CKSKEW} value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
- The T_{CKSKEW} is 0.43 ns for the XA6SLX100 device using a -2 speed grade and 0.22 ns for the XC6SLX100 devices using the -2 speed grade.

Table 79: Package Skew

| Symbol | Description | Device | Package ⁽²⁾ | Value | Units |
|----------------------|-----------------------------|--------|------------------------|-------|-------|
| T _{PKGSKEW} | Package Skew ⁽¹⁾ | LX4 | TQG144 | N/A | ps |
| | | | CPG196 | 23 | ps |
| | | | CSG225 | 58 | ps |
| | | LX9 | TQG144 | N/A | ps |
| | | | CPG196 | 23 | ps |
| | | | CSG225 | 58 | ps |
| | | | FT(G)256 | 88 | ps |
| | | | CSG324 | 64 | ps |
| | | LX16 | CPG196 | 19 | ps |
| | | | CSG225 | 70 | ps |
| | | | FT(G)256 | 71 | ps |
| | | | CSG324 | 54 | ps |
| | | LX25 | FT(G)256 | 90 | ps |
| | | | CSG324 | 61 | ps |
| | | | FG(G)484 | 84 | ps |
| LX25T | CSG324 | 48 | ps | | |
| | FG(G)484 | 112 | ps | | |